



**EXPEDITED PROCEDURE
GROUP ART UNIT 2814**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: JEUN et al.

Serial No.: 09/677,558

Title: SEMICONDUCTOR POWER
MODULE HAVING AN ELECTRICALLY
INSULATING HEAT SINK AND
METHOD OF MANUFACTURING THE
SAME

Filed: September 29, 2000

Group Art Unit: 2814

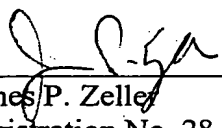
Examiner: DiLinh Nguyen

Atty. Docket Number: 29347/990488

Customer No.: 04743

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February 16, 2004



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AMENDMENT "C" AFTER FINAL REJECTION

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Commissioner for Patents
P.O. Box 1450
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Sir:

In response to the final official action dated December 15, 2003 the applicants respectfully request that the application be reconsidered in light of the following amendments and remarks.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Amendments to the Drawings begin on page 5 of this paper and include an attached replacement sheet.

Remarks begin on page 6 of this paper.